DP-313122, Page 1



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DELPHI TECHNOLOGIES, INC. Customer Number 22851 Legal Staff P.O. Box 5052 Mail Code: 480-410-202 Troy, Michigan 48007-5052 5-3/-05

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Enclosed for recording is	Assignment documentation for	r the following patent	application:
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Attorney Docket No.:

DP-313122

(1) Assignor/Inventors:

JEFFREY C. QUINTON TIMOTHY A. ALLISON DANIEL L. SCHNABEL BRAD J. SILVERS JOSEPH C. NEY ROBERT J. GRISSMAN

(2) Assignee:

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P.O. Box 5052 TROY, MICHIGAN

- (3) Assignment of patent application
- (4) Application number:

If blank, this documentation is filed together with the patent application.

(5) Address correspondence to:

Stefan V. Chmielewski

DELPHI TECHNOLOGIES, INC.

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(6) Number of applications:

Total Fee:

40.00

(7) Date documentation executed:

5/25/05

(8) Not applicable

(9) To the best of my knowledge and belief, the information contained on this cover sheet is true and correct and any copy submitted is a true copy of the original document.

Title:

FIRST DIE INDICATOR FOR INTEGRATED CIRCUIT WAFER

06/08/2005 ECDOPER 00000077 500831 11141338

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PATENT REEL: 016650 FRAME: 0962 Please charge the \$40.00 assignment recording fee to Delphi Technologies Deposit Account No. 05-0831.

Stefan V. Chmielewski (248)813-1220

Total number of pages including cover sheet, attachments and document: 3

Enclosures

PATENT REEL: 016650 FRAME: 0963

ASSIGNMENT

Pursuant to an agreement with my employer, I formally assign to DELPHI TECHNOLOGIES INC., the entire right, title and interest, in all countries, in the improvements set forth in the United States patent application DP-313122 entitled

FIRST DIE INDICATOR FOR INTEGRATED CIRCUIT WAFER

for which I executed a declaration dated as indicated below. If the patent application has been filed, I authorize the Vice President of Delphi Technologies, Inc., or his designate, to insert the application number and filing date of said application here in parentheses (
Inventor's signature	Jeffrey Columbia	Date 5/25/05		
Full name:	JEFFREY C. QUINTON	Declaration dated:		
Residence:	ROSSVILLE, INDIANA	5/25/05		
Inventor's signature	Timel Phillian	Date 5-25-05		
Full name:	TIMOTHY A. ALLISON	Declaration dated:		
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Inventor's signature	Davill Shabel	Date 5-25-05		
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Residence:

PATENT REEL: 016650 FRAME: 0964

Inventor's signature	Sough c. Ne	Date 5/25/05
Full name:	JOSEPH C. NEY	Declaration dated:
Residence:	GREENTOWN, INDIANA	5/25/05
Inventor's signature	Robert Trossman	Date 5/25/05
Full name:	ROBERT J. GROSSMAN	Declaration dated:
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PATENT
RECORDED: 05/31/2005 REEL: 016650 FRAME: 0965